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(12) United States Design Patent

Chen et al.

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(54) **LIGHT EMITTING DIODE**

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(**) Term: **15 Years**

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Related U.S. Application Data

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(30) **Foreign Application Priority Data**

Jun. 17, 2016 (TW) 105303468

(51) **LOC (12) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/180**

(58) **Field of Classification Search**
USPC D13/180; D26/1
CPC ... H01L 25/167; H01L 25/0753; H01L 27/15; H01L 27/156; H01L 31/02; H01L 33/00; H01L 33/04; H01L 33/08; H01L 33/10; H01L 33/20; H01L 33/38; H01L 33/42; H01L 33/48; H01L 33/483; H01L 33/486
See application file for complete search history.

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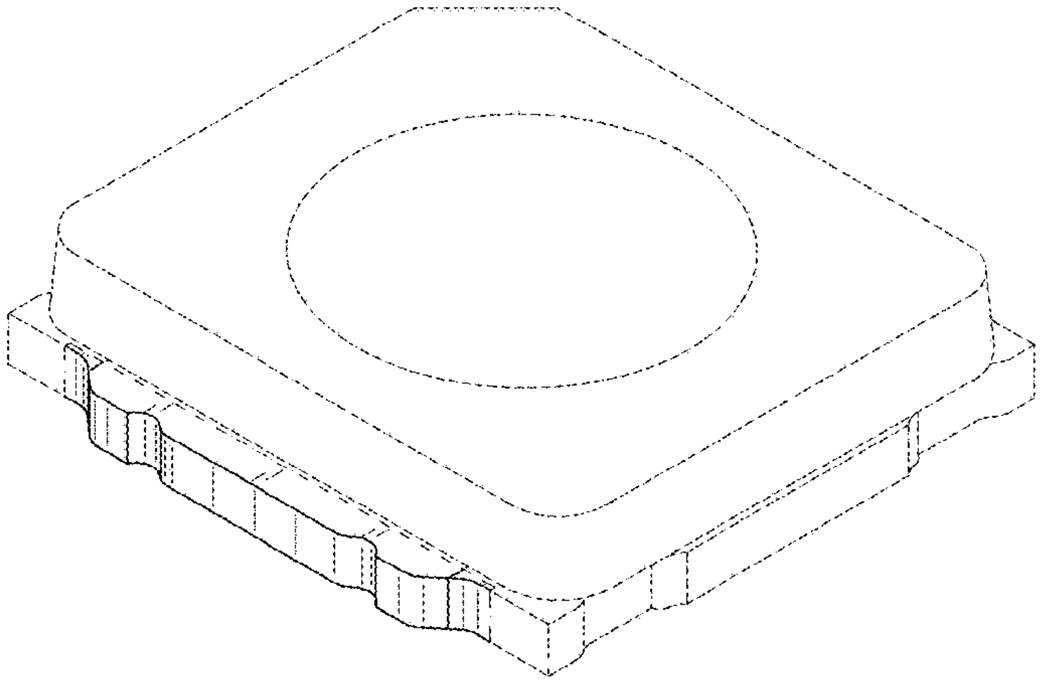
(57) **CLAIM**

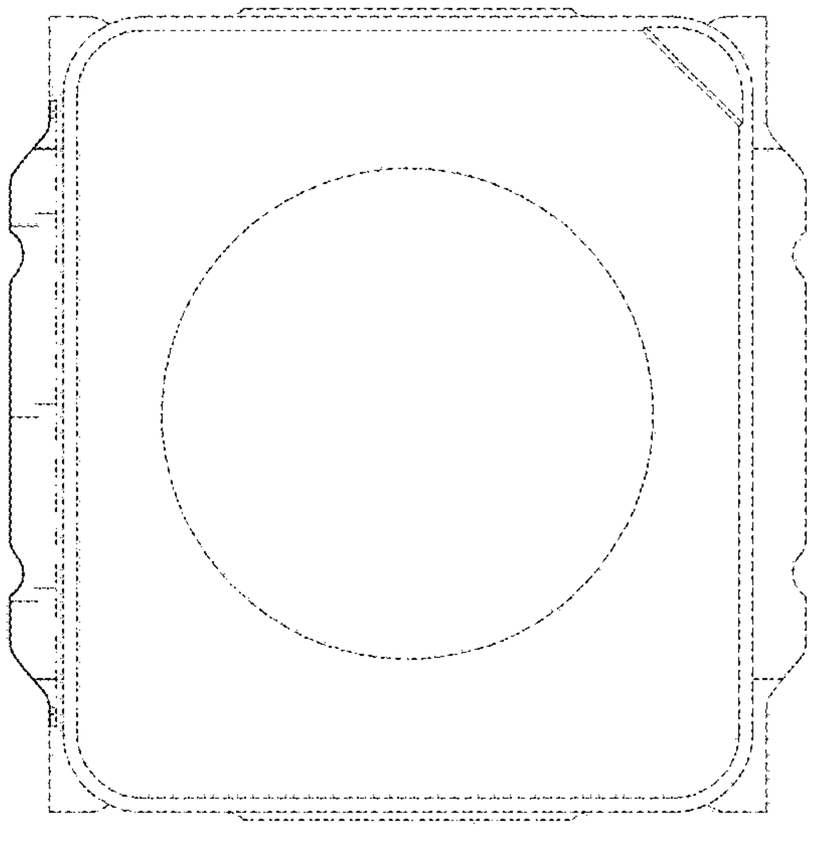
The ornamental design for a light emitting diode, as shown and described.

DESCRIPTION

FIG. **1** is a perspective view of a light emitting diode showing an embodiment of our new design;
FIG. **2** is another perspective view of the embodiment;
FIG. **3** is a front view of the embodiment;
FIG. **4** is a rear view of the embodiment;
FIG. **5** is a left side view of the embodiment;
FIG. **6** is a right side view of the embodiment;
FIG. **7** is a top view of the embodiment; and,
FIG. **8** is a bottom view of the embodiment.
The dashed line portions in the drawings form no part of the claimed design. The dot-dash lines in the drawings define the bounds of the claimed design and form no part thereof.

1 Claim, 6 Drawing Sheets





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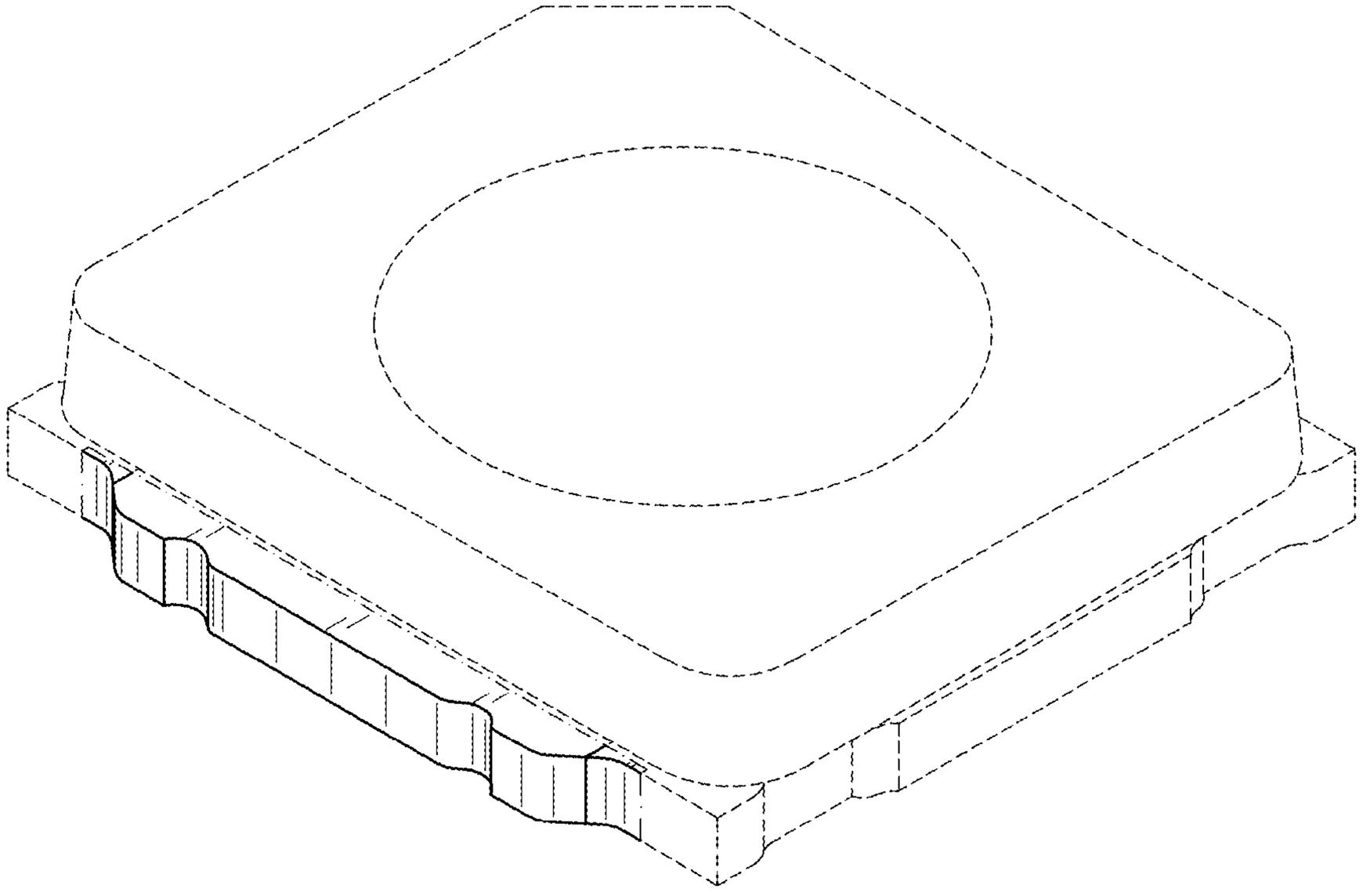

FIG. 1

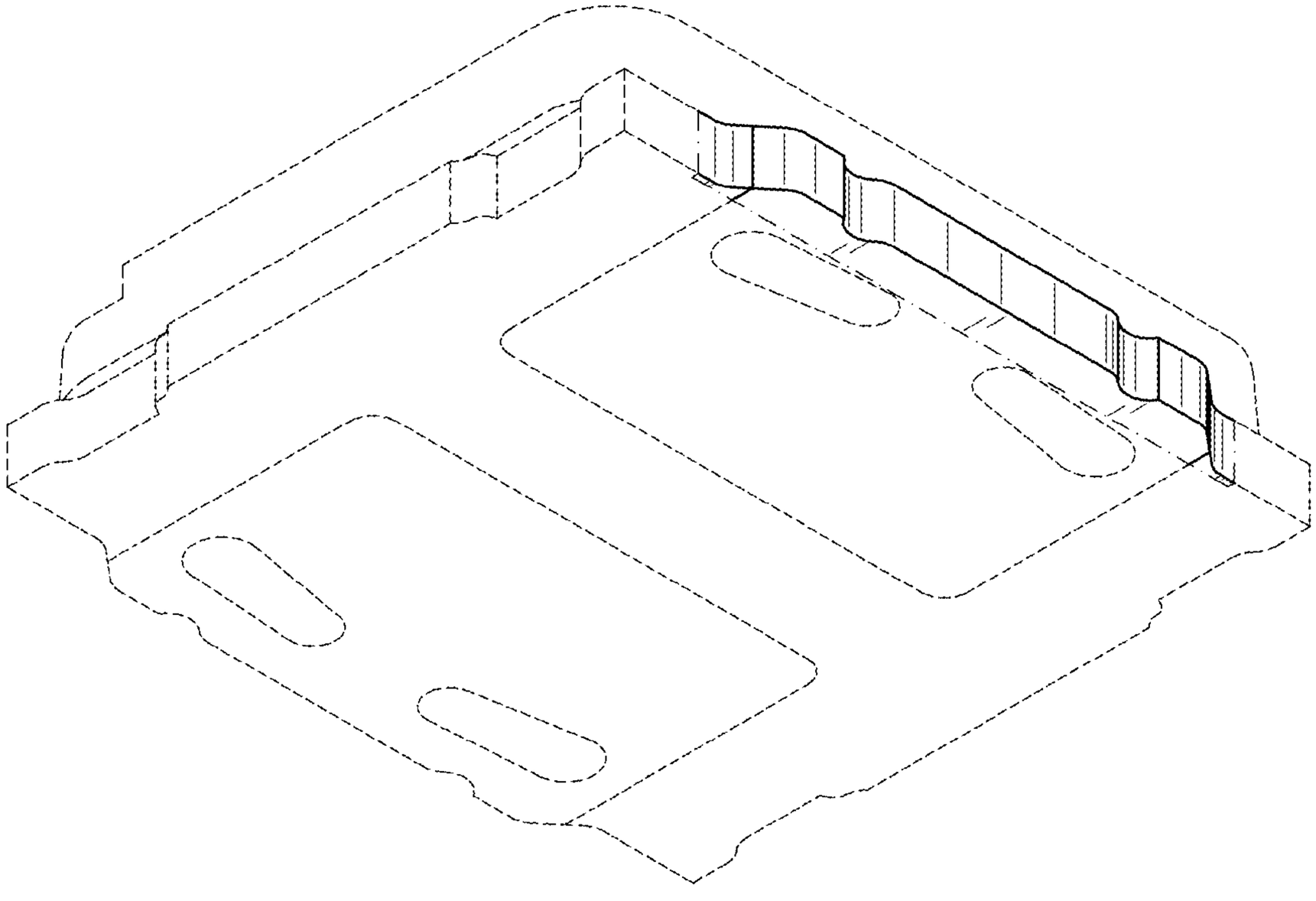

FIG. 2

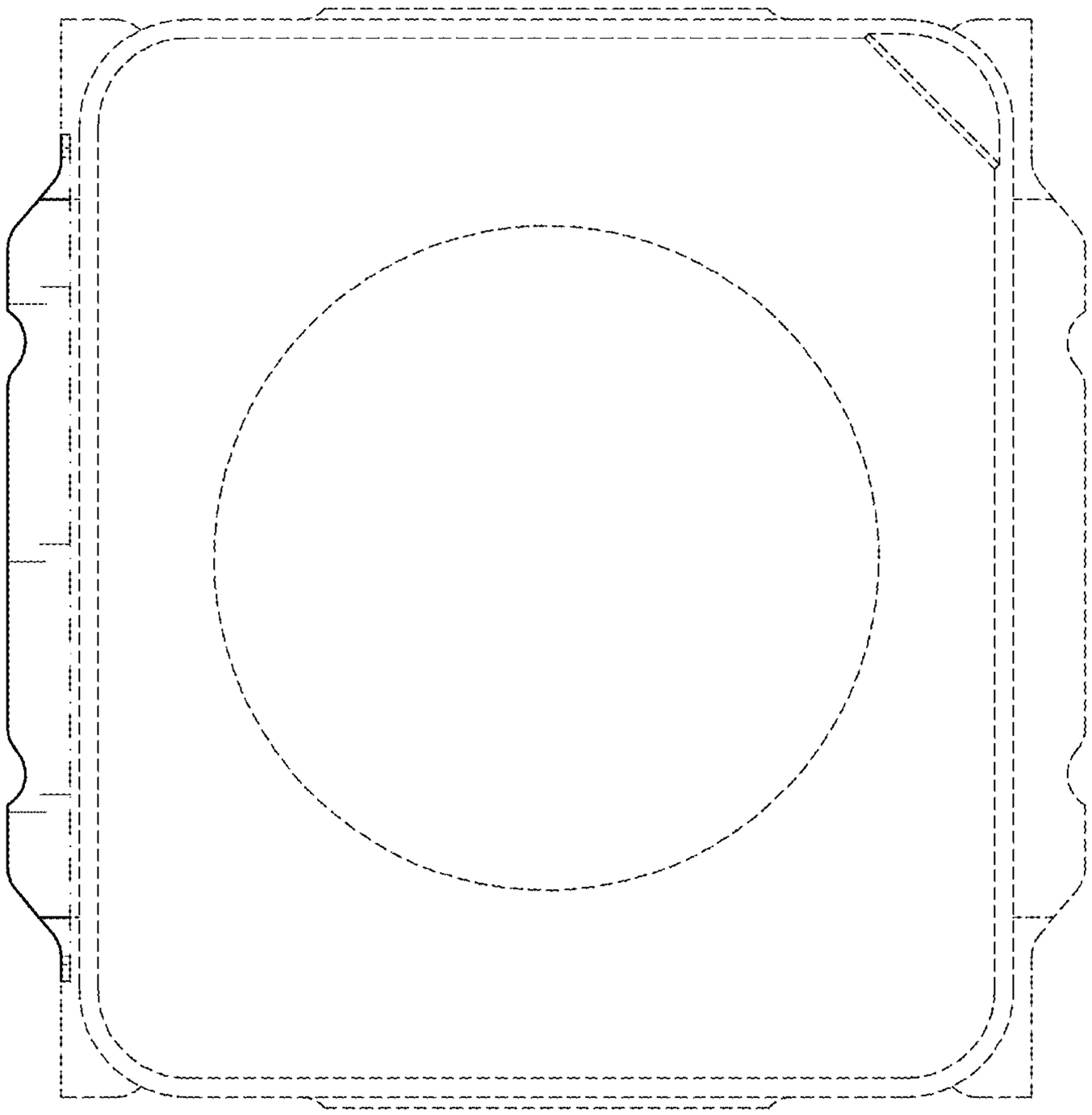

FIG. 3

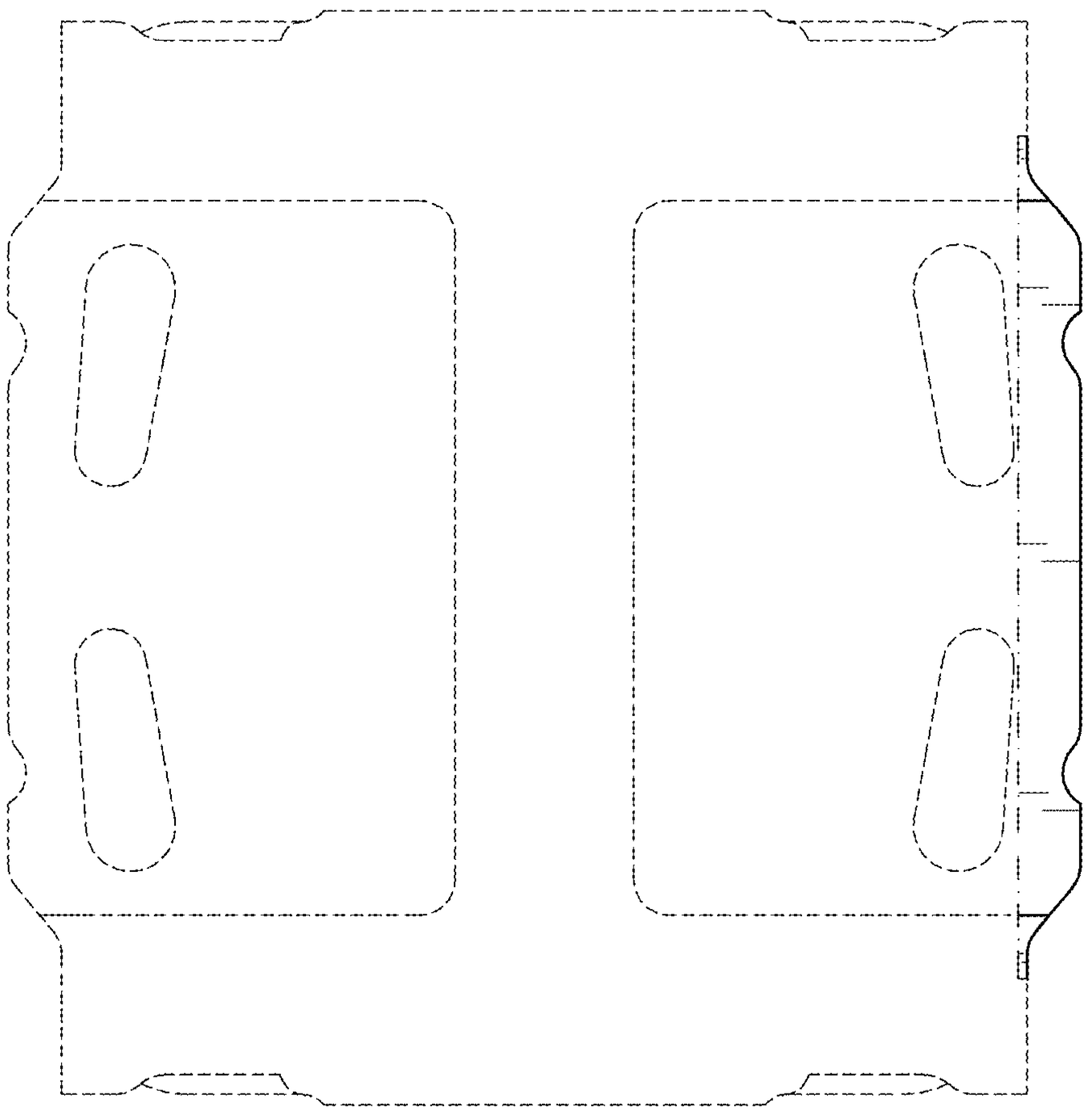

FIG. 4

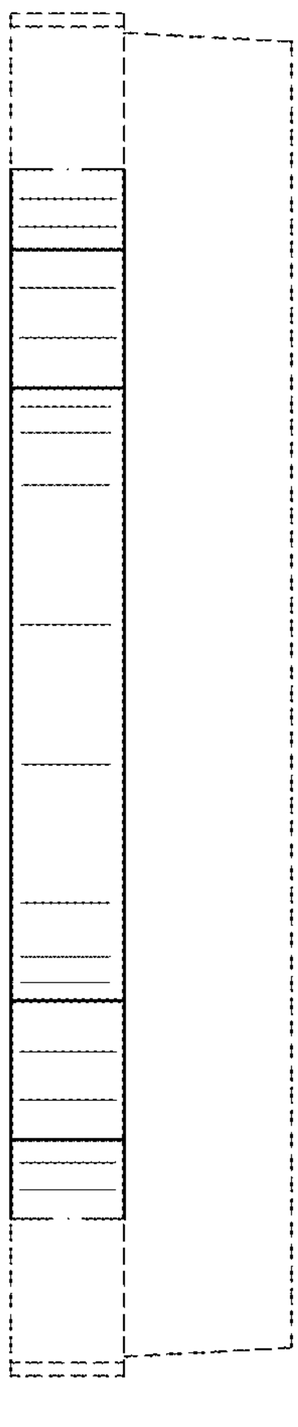

FIG. 5

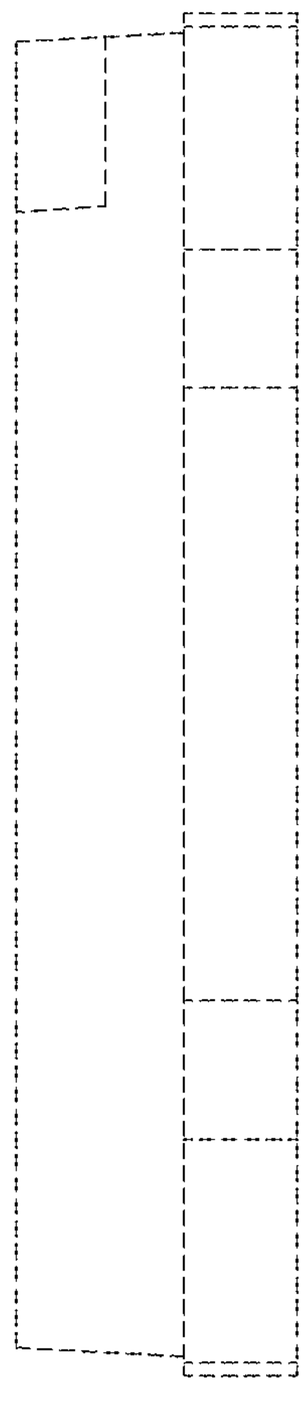

FIG. 6

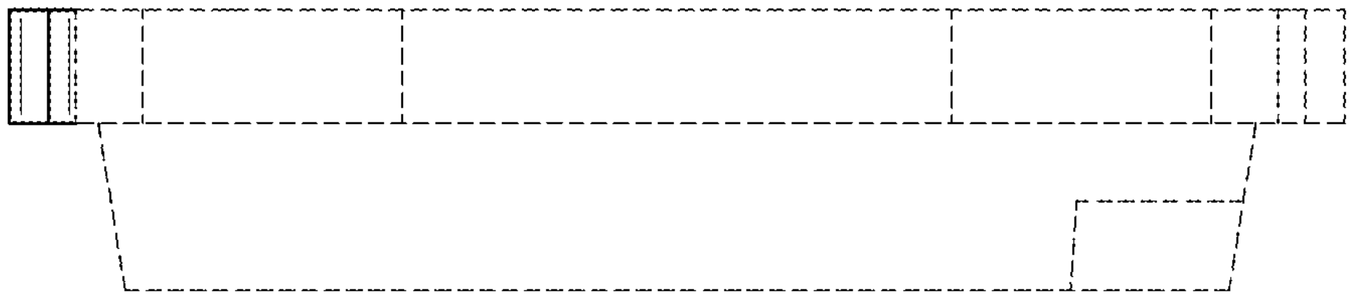

FIG. 7

FIG. 8